# **Advanced Magnetics**

Our magnetics are designed to provide high quality, uniform coatings for your application.

## **ADVANCED MAGNET SYSTEM FEATURES:**

- Multiple designs to fit your application requirements
- Advanced magnetics designed using 3D finite element analysis software
- High-strength magnets that are categorized in-house according to gauss level
- Fully encapsulated magnets and robust construction for many years of troublefree operation
- Long-life, multi-roller system for sputter up, sputter down, or off-angle sputtering
- · Simple magnetic uniformity tuning
- Easily installed in any possible orientation

#### **BENEFITS:**

- Industry leading coating uniformity up to +/- 1%
- Superior target utilization and reduced cross corner effects
- High deposition rates
- Lengthen campaign decrease downtime and increase productivity
- Adjustable sputter angle



**Advanced Magnet Bars** 

## **NEW SYSTEM INSTALLATIONS:**

- Most versatile rotary magnet systems available
- Use in any orientation
- Custom length magnet bars to ensure the perfect match for your system

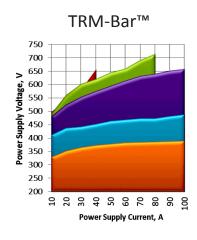
#### **UPGRADE OLD MAGNET BARS:**

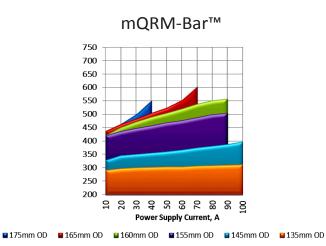
- Designed to adapt to other end block styles
- Reduce maintenance costs due to magnet, roller, and bushing replacement
- Increase process yields by reducing process drift
- Increase target utilization and save on target costs
- Fully encapsulated arrays eliminates corroded magnets

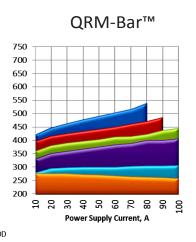


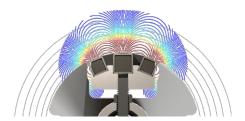


## **MAGNETICS FEATURES AND APPLICATIONS**

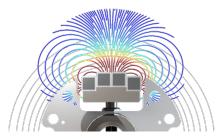








- Small magnet, 3-row design
- Narrowest deposition profile minimizes coating loss to shields
- Multiple turn-around design options specific to your application
- Easy change turn-arounds
- Target diameters up to 160mm OD



- Small magnet, 4-row design
- Patented staggered turnaround design
- Improved performance and reduced impedance
- Stable plasma impedance over the life of the target
- Increased target diameter up to 170mm OD



- Large magnet, 4-row design
  - Patented staggered turnaround design
- Improved performance
- Best plasma impedance stability over the life of the target
- Largest target diameter up to 180mm OD

| Model | Max Target<br>Diameter | Sputter Angle | Target Material Utilization | Application                                  |
|-------|------------------------|---------------|-----------------------------|--|
| TRM   | 160 mm                 | <u>+</u> 12°  | >70%<br>>80%*               | Thin Targets Acceptable for most material    |
| mQRM  | 170 mm                 | <u>+</u> 15°  | >85%                        | Thicker Targets,<br>High Utilization         |
| QRM   | 180 mm                 | <u>+</u> 21°  | >85%                        | Thickest Targets ITO, Electrical Grade Films |